

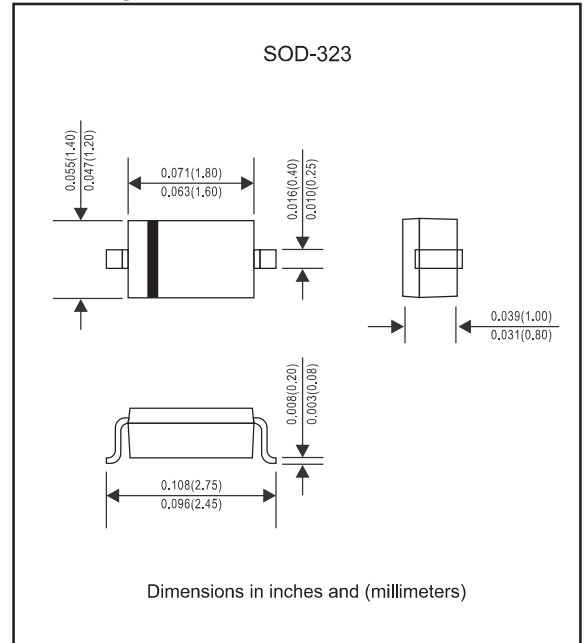
### Features

- Small package size for high density applications
- Ideally suited for automated assembly processes
- Pb-free package is available
- We declare that the material of product compliance with RoHS requirements
- Compliant to Halogen-free

### Mechanical data

- Epoxy: UL94-V0 rated flame retardant
- Case : Molded plastic, SOD-323
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any

### Package outline



### Maximum Ratings (at $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Power Dissipation <sup>(1)</sup>	$P_{\text{tot}}$	300	mW
Forward Voltage at $I_F = 10 \text{ mA}$	$V_F$	0.9	V
Thermal resistance junction to ambient	$R_{\theta JA}$	625	$^\circ\text{C/W}$
Operating junction	$T_j$	150	$^\circ\text{C}$
Storage temperature range	$T_{\text{stg}}$	-65 ~ +150	$^\circ\text{C}$

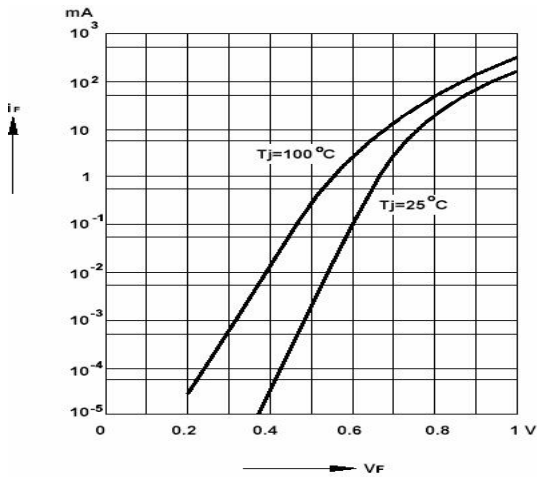
(1) FR-4 printed circuit board, single-sided copper, mounting pad  $1 \text{ cm}^2$ .

### Electrical Characteristics (at $T_a=25^\circ\text{C}$ unless otherwise noted)

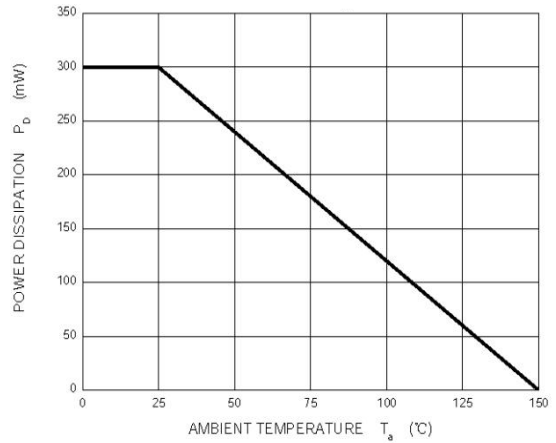
Device	Marking	Zener Voltage Range				Maximum Zener Impedance			Maximum Reverse Current		Typical Temperature coefficient @ $I_{ZTC} = \text{mV}/^\circ\text{C}$		Test Current $I_{ZTC}$
		$V_z @ I_{zt}$			$I_{zt}$	$Z_{zt} @ I_{zt}$	$Z_{zk} @ I_{zk}$	$I_{zk}$	$I_R$	$V_R$	Min	Max	
		Nom(V)	Min(V)	Max(V)	mA	$\Omega$	mA	$\mu\text{A}$	V				
BZT52B47S	2WV	47	46.06	47.94	2	100	750	1.0	0.1	35.0	10.0	12.0	5

## Rating and characteristic curves

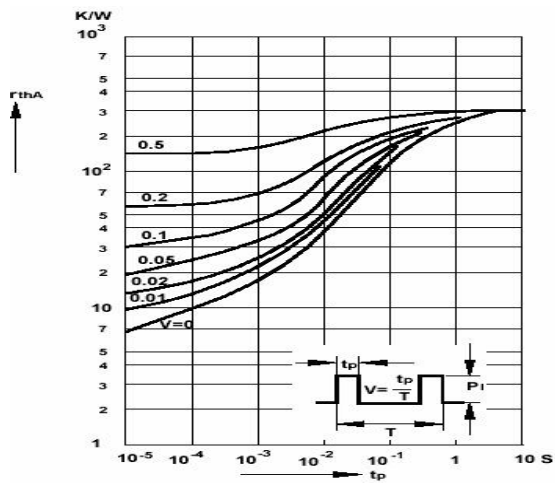
Forward characteristics



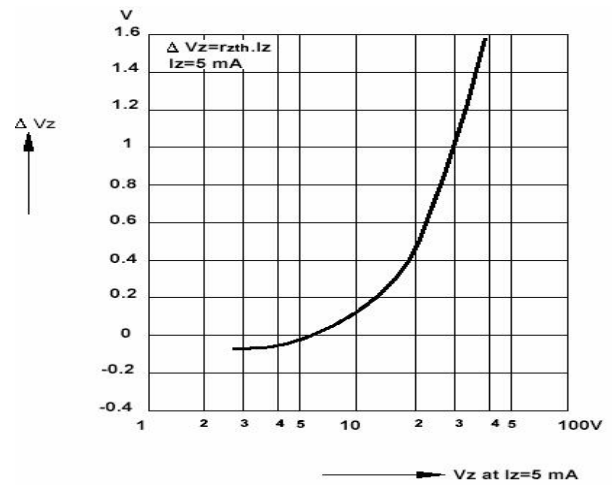
Admissible power dissipation versus ambient temperature



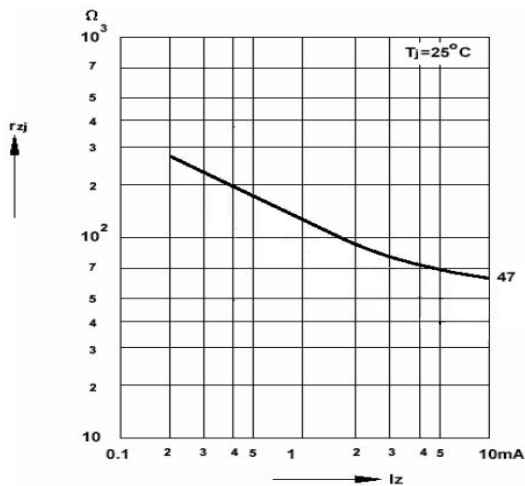
Pulse thermal resistance versus pulse duration



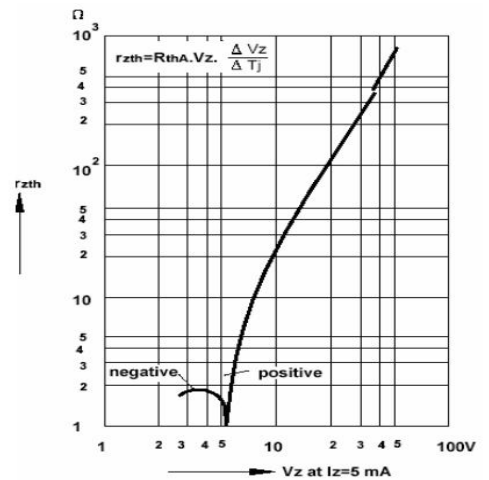
Change of Zener voltage from turn-on up to the point of thermal equilibrium versus Zener voltage



Dynamic resistance versus Zener current

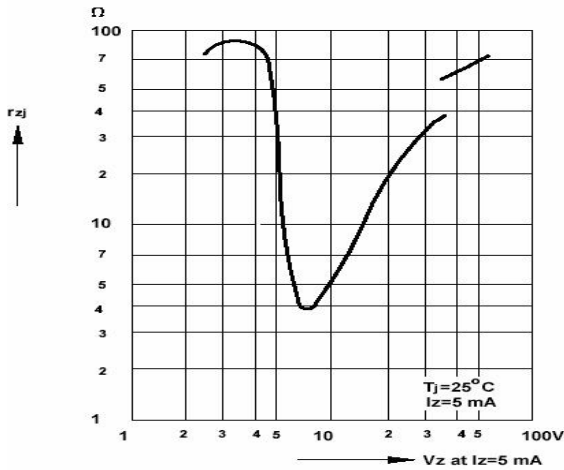


Thermal differential resistance versus Zener voltage

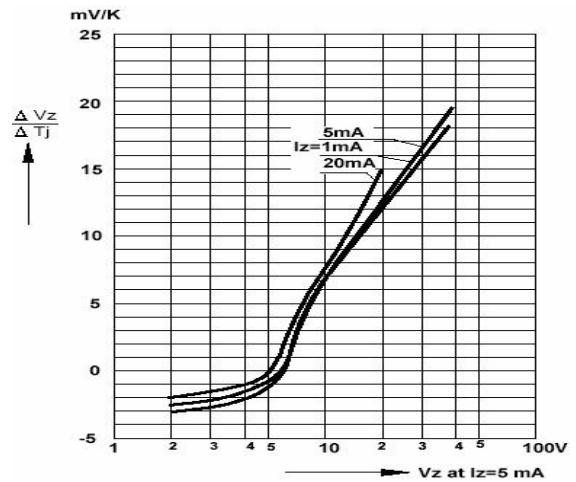


## Rating and characteristic curves

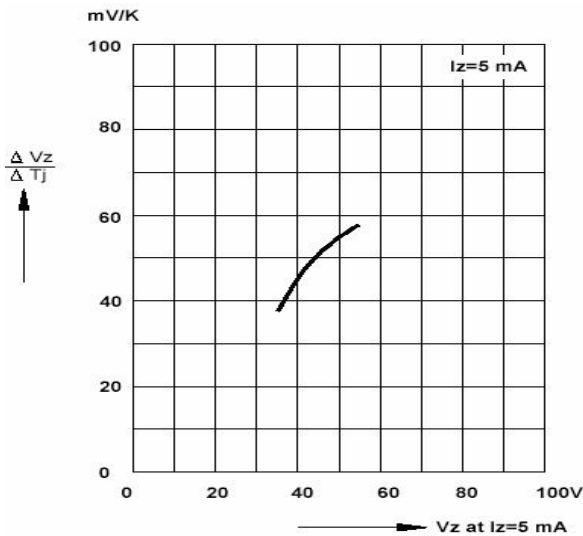
Dynamic resistance versus Zener voltage



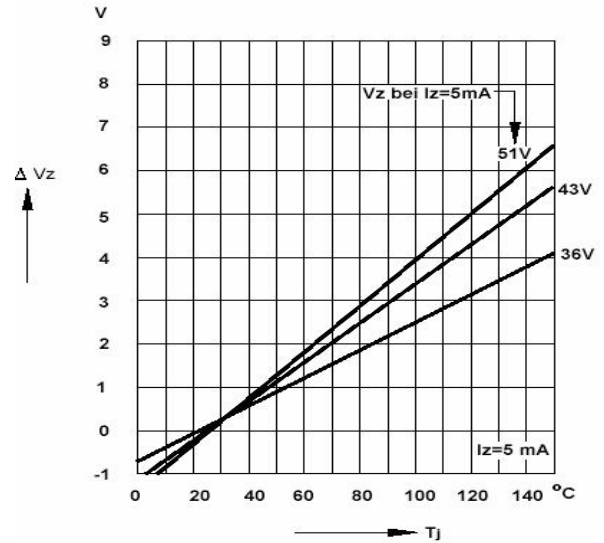
Temperature dependence of Zener voltage versus Zener voltage



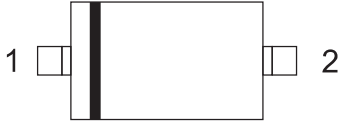

Temperature dependence of Zener voltage versus Zener voltage



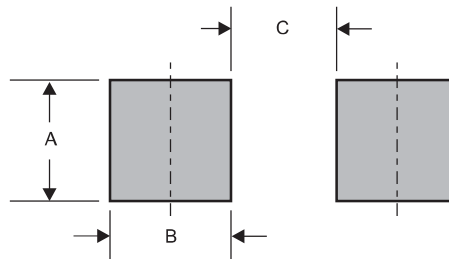
Change of Zener voltage versus junction temperature



## Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

## Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SOD-323	0.033 (0.83)	0.025 (0.63)	0.063 (1.60)